

Waterproof / Dustproof	No
Wire Insulation Diameter	N/A
Wire Size AWG	N/A

Electrical

Current - Maximum per Contact	0.5A
Grounding to Panel	N/A
Shielded	No
Voltage - Maximum	30V AC (RMS)/DC

Solder Process Data

Duration at Max. Process Temperature (seconds)	20
Lead-free Process Capability	Reflow Capable (SMT only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Application Specification	AS-75586-001
Electrical Model Document	EE-75586-001
Product Specification	PS-75586-001
S-Parameter Model	SP-75586-001
Sales Drawing	SD-75586-005

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